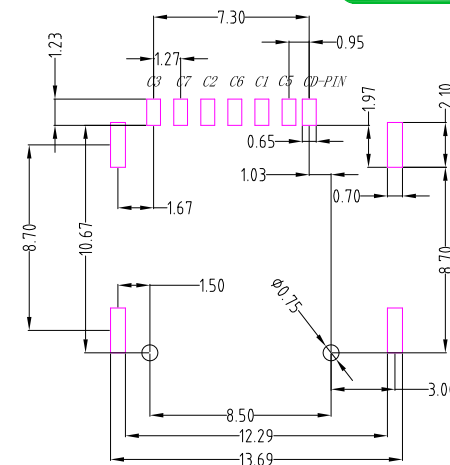
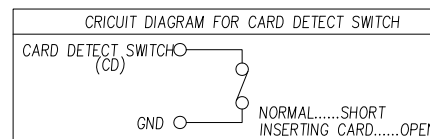




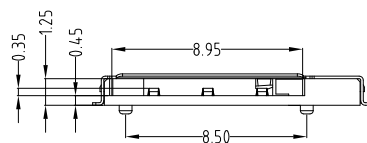
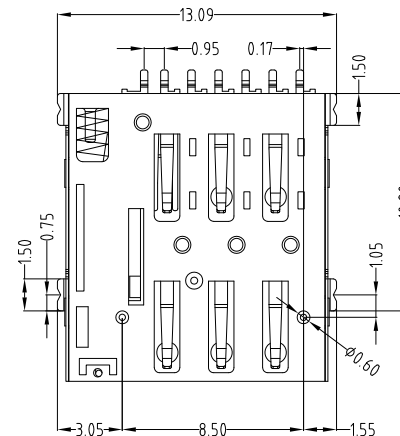
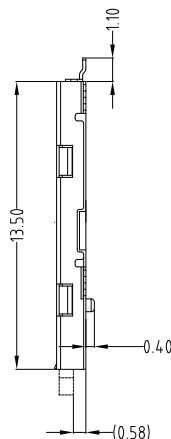
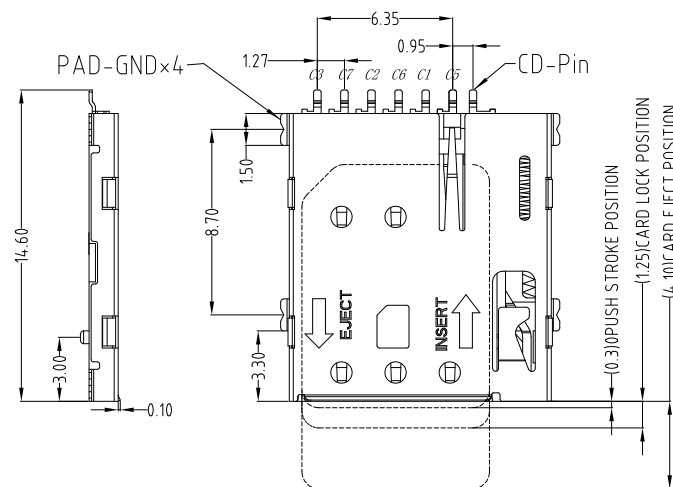
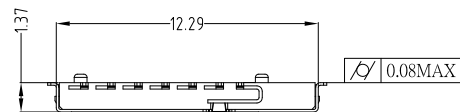
P.C.B LAYOUT

SPECIFICATION:

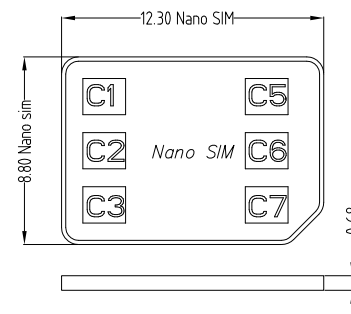
1. CURRENT RATING : 0.5A MAX.
2. VOLTAGE RATING : 125V AC / DC
3. INSULATION RESISTANCE : 1000M Ω MIN.
4. CONTACT RESISTANCE : 100m Ω MAX.
5. OPERATING TEMPERATURE RANGE : -40°C TO +80°C.
6. STORAGE TEMPERATURE RANGE : -20°C TO +70°C.

MATERIALS:

1. HOUSING : LCP
 2. CONTACT : PHOSPHOR BRONZE
 3. SHELL : SUS
- Finish:
1. Finish: CONTACT: PLATED GOLD IN MATING AREA ;
GOLD PLATED ON SOLDER BALLS ;
NICKEL UNDER PLATED OVERALL
 2. SHELL: NICKEL UNDER PLATED SURFACE LAYER



SIM pin assignment	
PIN#	Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O



广东科斯达电子科技有限公司
GUANG DONG KE SI DA ELECTRONIC TECHNOLOGY CO., LTD.

TOLERANCE UNLESS OTHERWISE STATED :
Up to 5 ± 0.2
Above 5 ~ 15 ± 0.3
Above 15 ~ 30 ± 0.4
Above 30 ~ 50 ± 0.5
Angle ± 0.3

3RD.
ANGEL'S



UNITS

MM

DRAWN BY: Jack Lu
CHECKED BY: Jacky Chen
APPROVED BY: Tony Kao

DATE: 12/27/23
DATE: 12/27/23
DATE: 12/27/23

MAT'L	TITLE	CONNECTOR
FINISH	MODLE	Nano SIM CARD PUSH PUSH H1.37
SCALE	DWG NO.	NSIM-019107A-S267
SHEET NO.	PART NO.	NSIM-019107A-S267

SIZE
A4
VER
R